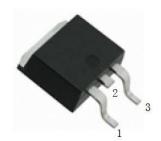
MJD127R-HAF

PNP Silicon Power Darlington Transistor

Features

• Halogen and Antimony Free(HAF), RoHS compliant



1.Base 2.Collector 3.Emitter TO-252 Plastic Package

Absolute Maximum Ratings (T_a = 25°C unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Collector Base Voltage	-V _{CBO}	100	V	
Collector Emitter Voltage	-Vceo	100	V	
Emitter Base Voltage	-V _{EBO}	-V _{EBO} 5		
Collector Current	-Ic	-lc 8		
Peak Collector Current, Pulsed	-Ісм	-I _{CM} 16		
Base Current	-I _B	120	mA	
Total Dissipation T _C = 25°C	P _{tot}	20	W	
Total Dissipation 1) T _a = 25°C	P _{tot}	1.75	W	
Operating Junction and Storage Temperature Range	T_{j}, T_{stg}	- 65 to + 150	°C	

Thermal Characteristics

Parameter	Symbol	Max.	Unit		
Thermal Resistance from Junction to Case	R ₀ JC	6.25	°C/W		
Thermal Resistance from Junction to Ambient 1)	Reja	71.4	°C/W		

¹⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



MJD127R-HAF

Characteristics at $T_C = 25$ °C unless otherwise specified

Parameter	Symbol	Min.	Max.	Unit
DC Current Gain at -V _{CE} = 4 V, -I _C = 4 A at -V _{CE} = 4 V, -I _C = 8 A	h _{FE}	1000 100	12000 -	
Collector Base Breakdown Voltage at -I _C = 100 µA	-V(BR)CBO	100	-	V
Collector Emitter Breakdown Voltage at -I _C = 30 mA	-V(BR)CEO	100	-	V
Emitter Base Breakdown Voltage at -l _E = 2.5 mA	-V(BR)EBO	5	-	V
Collector Emitter Cutoff Current at -V _{CE} = 50 V	-Iceo	-	10	μΑ
Collector Base Cutoff Current at -V _{CB} = 100 V	-I _{CBO}	-	10	μΑ
Emitter Base Cutoff Current at -V _{EB} = 5 V	-lebo	-	2	mA
Collector Emitter Saturation Voltage at $-I_C = 4 \text{ A}$, $-I_B = 16 \text{ mA}$ at $-I_C = 8 \text{ A}$, $-I_B = 80 \text{ mA}$	-VCE(sat)		2 4	V
Base Emitter Saturation Voltage at $-I_C = 8 A$, $-I_B = 80 mA$	-V _{BE(sat)}	-	4.5	V
Base-Emitter On Voltage at -V _{CE} = 4 V, -I _C = 4 A	-V _{BE(on)}	-	2.8	V
Current Gain Bandwidth Product at -V _{CE} = 4 V, -I _C = 3 A, f = 1 MHz	f⊤	4	-	MHz
Output Capacitance at -V _{CB} = 10 V, I_E = 0, f = 1 MHz	Cob	-	300	pF



Electrical Characteristics Curves

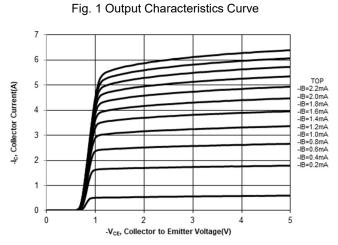


Fig. 2 Collector Current vs. VBE

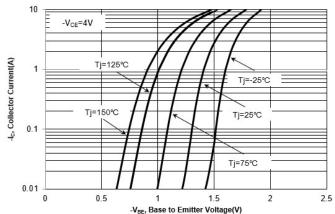


Fig. 3 h_{FE} vs. Collector Current

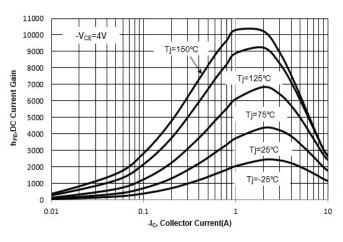


Fig. 4 V_{BE(sat)} vs. Collector Current

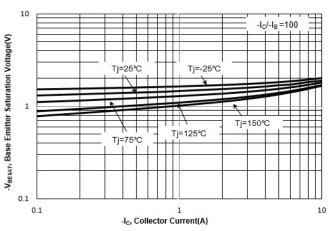


Fig. 5 V_{CE(sat)} vs. Collector Current

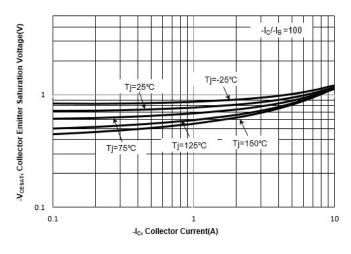
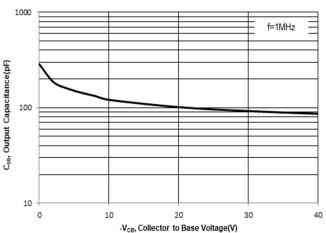


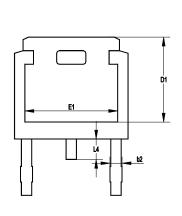
Fig 6. Output Capacitance

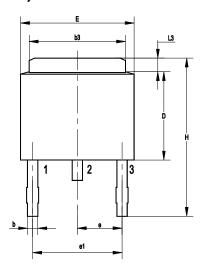


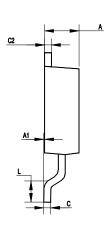


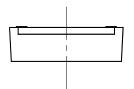
Package Outline (Dimensions in mm)

TO-252



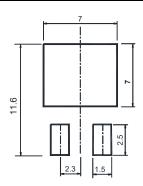






U	TIN	Α	A1	b	b2	b3	С	C2	D	D1	Е	E1	е	e1	Н	L	L3	L4
		2.5	0.15	1.0	1.15	5.5	0.65	0.65	6.2	5.4	6.7	5.0	2.30	4.60	10.7	1.78	1.20	1.10
l n	nm	2.1	0	0.5	0.65	4.9	0.4	0.4	5.6	5.0	6.1	4.6	TYP.	TYP.	9	1.40	0.85	0.51

Recommended Soldering Footprint



Packing information

Package	Tape Width	Pit	ch	Reel	Size	Per Reel Packing Quantity
Fackage	(mm)	mm	inch	mm	inch	Fel Neel Fackling Qualitity
TO-252	16	8 ± 0.1	0.315 ± 0.004	330	13	2,500

Marking information

" MJD127R " = Part No.

" ***** " = Date Code Marking

Font type: Arial



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